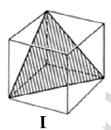
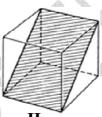
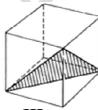
- 1. Calculate the total volume of atoms in an FCC lattice.
 - $(A) \quad \frac{4}{3}\pi r^3$
 - (B) $\frac{8}{3}\pi r^3$

 - (D) $\frac{16}{3}\pi r^3$
- 2. Calculate the inter-planar spacing of (211) plane of a monoclinic lattice, given lattice constants a = 4.683 Å, b = 3.421 Å, c = 5.129 Å and $\alpha = \beta = \gamma = 90^{\circ}$.
 - (A) 6.6 Å
 - (B) 5.2 Å
 - (C) 7.9 Å
 - (D) 4.8 Å
- Which one of the figures depict the $(1\overline{1}1)$ plane of the cubic lattice? 3.

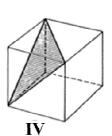




 \mathbf{II}



Ш



- (A)
- II (B)
- Ш (C)
- (D) IV
- 4. Calculate the lattice constant of the cubic cell of a crystal if X-rays of wavelength 0.714 Å are diffracted from the (100) plane at an angle of 30.5° in the second order.
 - (A) 2.814 Å
 - 1.407 Å (B)
 - (C) 2.672 Å
 - (D) 3.082 Å

5. p-1	type doping of III-V semiconductor GaAs is done by implanting
(1	A) Si B) P C) Ga D) Ge
6. Aı	rrange the following in increasing order of their resistivity.
() () () () ()	II) SiO ₂ III) Si IIII) ZnO IV) Zn A) (IV), (III), (II), (I) B) (II), (IV), (III), (I) C) (II), (III), (IV), (I) D) (IV), (III), (III), (I)
se:	etermine the ratio of effective mass of electron and hole in an intrinsic miconductor with band gap $E_g = 0.7$ eV and Fermi level $E_F = 0.3847$ eV. A) 0.34 B) 0.10 C) 0.16 D) 0.85
Th (, () ()	ensity of states for 2D-confined electrons in a nanowire varies with energy as E^{α} . The value of α is A) 2 B) -0.5 C) 0.5 D) 0
(, () ()	entify the group of polar solvents. A) Ethanol, Acetic acid, Methanol B) Benzene, Chloroform, Acetic acid C) Ethanol, Methanol, Benzene D) Chloroform, Acetic acid, Ethanol

- 10. Arrange the following materials in increasing order of their band gap.
 - (A) Ge, Si, GaAs, InP
 - (B) InP, Ge, GaAs, Si
 - (C) GaAs, Si, InP, Ge
 - (D) Ge, Si, InP, GaAs
- 11. Which one of the following is the expression for Hall coefficient? (all symbols have their usual meanings)
 - (A) $\frac{1}{n^2q}$
 - (B) $\frac{V_H}{nq}$
 - (C) $\frac{n_p \mu_p^2 n_n \mu_n^2}{e \left(n_p \mu_p + n_n \mu_n\right)^2}$
 - (D) $\frac{BI}{\rho w}$
- 12. The carrier diffusion coefficient of a non-degenerate semiconductor is given by (all symbols have their usual meanings)
 - (A) $\frac{kT\mu}{q}$
 - (B) $\frac{q\mu}{kT^2}$
 - (C) $\frac{kT}{q\mu}$
 - (D) $\frac{\mu}{kT}$
- 13. A p-n junction with acceptor concentration of 10^{17} cm⁻³ (p-type) and donor concentration of 10^{16} cm⁻³ (n-type). The depletion layer length will be of the order of (Assume T = 300 K and $n_i = 10^{10}$ cm⁻³)
 - (A) 100 nm
 - (B) 10 nm
 - (C) $10 \mu m$
 - $(D) \quad 100 \; \mu m$

14.	The slope of $\frac{1}{C^2}$ vs. V of a Schottky diode is proportional to
	1



(C)
$$N^2$$

(D)
$$\frac{1}{N^2}$$

15. What is the value of R_S (in Ohms) required to self-bias an N-channel JFET with $V_P = -10 \text{ V}$, $I_{DSS} = 40 \text{ mA}$ and $V_{GSQ} = -5 \text{ V}$?

16. The energy values of surface quantized states in the inversion layer of a MOS capacitor is given by

(A)
$$E_n \propto n^{1/2}$$

(B)
$$E_n \propto n^2$$

(B)
$$E_n \propto n^2$$

(C) $E_n \propto n^{2/3}$

(D)
$$E_n \propto n^{3/2}$$

In a reverse biased p-n junction, Zener breakdown is caused by 17.

- barrier widening (A)
- tunneling (B)
- (C) avalanching
- (D) capacitance

Silicon cannot be used to make LED because of 18.

- (A) direct band gap
- indirect band gap (B)
- (C) wide band gap
- (D) narrow band gap

20.	The do	oping concentration of the emitter (E) , base (B) and collector (C) region of a
		l BJT varies as
	• •	
	` ′	E > B > C
	` /	C > B > E
	, ,	E > C > B
	(D)	C > E > B
21.	Which	of the following is not an ideal metal for ohmic contact with p-Si?
	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	a of the following to those the following to the followin
	(A)	Pt
		Ag
	(C)	
	(D)	Ni
22.	The de	epletion layer width in the metal side of a Schottky barrier
,	1110 0	-provide myst without the decision of the continuity current
	(A)	depends on the work function of the metal
	(B)	depends on the doping concentration of the semiconductor
	(C)	depends on the applied bias
	(D)	negligible
23.	The Ir	$_{D}$ vs. V_{D} graphs of a MOSFET shows saturation due to
23.	THC IL	y vs. v _D graphs of a Wood L1 shows saturation due to
	(A)	pinch off
	(B)	punch through
	(C)	mobility decrease
	(D)	high depletion width
24.	The fo	ollowing is not true for a FET device.
4 7.	THC IC	mowing is not true for a LL1 device.
	(A)	It is a voltage controlled device
	(B)	It is bipolar
		Has high input impedance
	(D)	Current conduction by majority carriers

The following occurs in a Schottky diode but **not** in a p-n junction diode

(C) high ideality factor (> 1.2) due to recombination in depletion layer

(A) forward current due to minority carriers

(D) majority carrier transport in forward bias

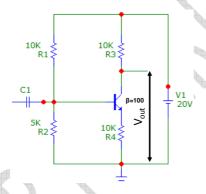
(B) strong temperature dependent reverse bias current

19.

- 25. A Germanium diode has a reverse saturation current of $0.19~\mu A$. Find the current in the diode when it is forward biased with 0.3~V at $27^{\circ}C$.
 - (A) 1 mA
 - (B) 11 mA
 - (C) 21 mA
 - (D) 31 mA
- 26. A Si MOS capacitor with a SiO₂ dielectric having thickness of 1 nm is fabricated. In order to have the same capacitance, what will be dielectric thickness required if HfO₂ is used as the insulator?

(Take dielectric constants of SiO₂ and HfO₂ to be 4 and 24, respectively)

- (A) 2 nm
- (B) 4 nm
- (C) 6 nm
- (D) 8 nm
- 27. Given figure shows a Si-transistor employed as a CE mode amplifier. The quiescent collector voltage of the circuit (V_{out}) is approximately.



- (A) 14 V
- (B) 10 V
- (C) $\frac{16}{3}$ V
- (D) 20 V
- 28. Which type of BJT configuration has high output impedance but low input impedance?
 - (A) CB mode
 - (B) CC mode
 - (C) CE mode
 - (D) Both (A) and (C)

29.		nreshold voltage of an n-channel enhancement mode MOSFET is 0.5 V. When the e is biased at a gate voltage of 3 V, pinch-off would occur at a drain voltage of
	(A)	2 V
	(B)	2.5 V
	(C)	3 V
	(D)	3.5 V
30.	Whic	h of the following cannot be used as a solar cell material?
	(A)	Si
	(B)	GaAs
	(C)	CdS
	(D)	PbS
31.	To de	tect red light (wavelength 870 nm), the ideal material would be
	(A)	Si
	(B)	Ge
	(C)	InP
	(D)	GaAs
32.	The s	pectral broadening of a LED is due to
.) 4.		
32.		
32.	(A)	uncertainty principle
32.	(A) (B)	uncertainty principle temperature
<i>32</i> .	(A) (B) (C)	uncertainty principle temperature both (A) and (B)
32.	(A) (B)	uncertainty principle temperature
32.	(A) (B) (C)	uncertainty principle temperature both (A) and (B)
33.	(A) (B) (C) (D)	uncertainty principle temperature both (A) and (B)
	(A) (B) (C) (D)	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED
	(A) (B) (C) (D) On de	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases
	(A) (B) (C) (D) On de (A) (B)	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases increases
	(A) (B) (C) (D) On de	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases
	(A) (B) (C) (D) On de (A) (B) (C)	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change
33.	(A) (B) (C) (D) On def (A) (B) (C) (D)	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above
	(A) (B) (C) (D) On de (A) (B) (C) (D)	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above
33.	(A) (B) (C) (D) On de (A) (B) (C) (D)	uncertainty principle temperature both (A) and (B) None of the above ecreasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above
33.	(A) (B) (C) (D) On de (A) (B) (C) (D) For we through	uncertainty principle temperature both (A) and (B) None of the above cereasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above which of the following diodes when the voltage is increased the current flowing gh it decreases? Tunnel diode
33.	(A) (B) (C) (D) On de (A) (B) (C) (D) For w through	uncertainty principle temperature both (A) and (B) None of the above cereasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above which of the following diodes when the voltage is increased the current flowing gh it decreases? Tunnel diode Schottky diode
33.	(A) (B) (C) (D) On de (A) (B) (C) (D) For w through	uncertainty principle temperature both (A) and (B) None of the above cereasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above which of the following diodes when the voltage is increased the current flowing gh it decreases? Tunnel diode Schottky diode Laser diode
33.	(A) (B) (C) (D) On de (A) (B) (C) (D) For w through	uncertainty principle temperature both (A) and (B) None of the above cereasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above which of the following diodes when the voltage is increased the current flowing gh it decreases? Tunnel diode Schottky diode
33.	(A) (B) (C) (D) On de (A) (B) (C) (D) For w through	uncertainty principle temperature both (A) and (B) None of the above cereasing the quantum well width, the emission wavelength of a quantum well LED decreases increases does not change None of the above which of the following diodes when the voltage is increased the current flowing gh it decreases? Tunnel diode Schottky diode Laser diode

	(B)	Speed
	(C)	Coherence
	(D)	Wavelength
36.	The d	legenerate source/drain doping of a MOSFET is known as
	(A)	High density doping
	(B)	Low density doping
	(C)	Medium density doping
	(D)	None of the above
		12
37.	A sili	con semiconductor slab has absorption coefficient of $10^{12} \mathrm{cm}^{-1}$ at wavelength of
	1 μm	. If 90% of the incident flux is to be absorbed, then the thickness of the slab
	requir	red is
	(A)	0.23 nm
	(B)	0.0105 nm
	` ′	0.10 nm
	(D)	0.0045 nm
38.	The b	band gap in semiconductor is $\Delta E = 0.68$ eV. Assuming that the number of hole-
		on pairs is proportional to $e^{-\Delta E/2kT}$, the percentage increase in the number of
		e carriers in pure germanium as the temperature is increased from 300 K to 320 K is
	charge	e carriers in pure germanium as the temperature is increased from 500 K to 520 K is
	(A)	10%
	(B)	27%
	(C)	127%
	(D)	100%
4		21-1
39.	ASS .	electron and hole mobilities in Si at room temperature are $0.135 \text{ m}^2\text{V}^{-1}\text{s}^{-1}$ and
	0.048	$\text{m}^2\text{V}^{-1}\text{s}^{-1}$ respectively. If the carrier concentration is $1.5 \times 10^{16} \text{ m}^{-3}$, its
	resisti	ivity at room temperature is
	(A)	1.2 Ωm
	(B)	2.3 Ωm
	(C)	3.5 Ωm
	(D)	$4.1~\Omega\mathrm{m}$

Which of the following is a unique property of laser?

(A) Directionality

35.

- 40. The value of Klitzing constant is
 - (A) $25.8 \text{ k}\Omega$
 - (B) $24.9 \text{ k}\Omega$
 - (C) $26.0 \text{ k}\Omega$
 - (D) $26.2 \text{ k}\Omega$
- 41. The interconnects in an integrated circuit are made during
 - (A) Lithography process
 - (B) Epitaxy
 - (C) Emitter diffusion process
 - (D) Metallization process
- 42. Moore's law is related to
 - (A) power rating of a MOS device
 - (B) power rating of a bipolar device
 - (C) integration of MOS device
 - (D) integration of bipolar device
- Transconductance of a MOSFET operating in the linear region is approximated by 43.
 - (A) $K(V_{GS} V_{th})$
 - (B) $I_D \left(V_{GS} V_{th}\right)^2$
 - (C) $I_D/(V_{GS}-V_{th})$
 - (D) KV_{DS}
- For an n-channel MOSFET, if conduction parameter k_n is 0.249 mA/V², gate to 44. source voltage V_{GS} is $2V_{th}$ where $V_{th} = 0.75$ V. The drain current for large V_{DS} will be
 - (A) 0.160 mA (B) 0.150 mA

 - (C) 0.140 mA
 - (D) 0.170 mA

45.	An enhancement type NMOS transistor has $V_{th} = 0.7$ V. Its source terminal grounded
	and 1.5 V is applied at the gate. If a drain bias of 0.5 V is applied, what will be the
	region of operation?

- (A) Triode
- Saturation (B)
- (C) Cut-off region
- (D) None of the above
- 46. Match the following list.

List 1 List 2 Current gain common base 1 (unity) (a) (i) Input impedance in common base Less than unit (ii) (b) Very high

- Voltage gain in common collector (iii) (c)
- Output impedance in common base (iv) Lowest (d)
- (A) (a)-(i), (b)-(ii), (c)-(iii), (d)-(iv)
- (a)-(iii), (b)-(i), (c)-(iv), (d)-(ii) (B)
- (C) (a)-(iv), (b)-(iii), (c)-(ii), (d)-(i)
- (D) (a)-(ii), (b)-(iv), (c)-(i), (d)-(iii)
- In a BJT switching circuit, the supply voltage V_{CC} is 9 V. The biasing resistors are 47. $R_B = 15 \text{ k}\Omega$ and $R_C = 6.8 \text{ k}\Omega$. The transistor has an h_{FE} of 25. What will be the minimum input voltage required to operate in saturation mode, given that $V_{CE} = 0.2 \text{ V}$?
 - 1.48 V (A)
 - (B) 0.78 V
 - (C) 5 V
 - (D) 3.3 V
- Holes are injected at room temperature into a long p-type ($N_A = 10^{17} \text{ cm}^{-3}$) Si bar with 48. cross-sectional area of 0.5 cm^2 , such that the steady state hole concentration is 10^{17} cm^{-3} at x = 0. What is the separation between the conduction band (E_c) and hole quasi Fermi level (F_p) at x = 50 nm? Take $\mu_p = 1000$ cm²/(Vs), $\tau_p = 1$ ns and $n_i = 10^{10}$ cm⁻³.
 - (A) 1.01 eV
 - (B) 0.985 eV
 - (C) 0.90 eV
 - (D) 0.93 eV

- 49. A n⁺ polysilicon gate n-channel MOS transistor is made on a p-type Si substrate with N_A = 5 × 10¹⁵ cm⁻³. The maximum depletion width will be in the range of
 (A) 0.6 nm
 (B) 0.5 cm
 (C) 0.4 μm
 (D) 0.3 mm
 50. For scaling of MOSFETs according to a constant factor of 'k', the following quantity does **not** change.
 - (A) Voltage
 - (B) Current density
 - (C) Capacitance
 - (D) Transconductance
- 51. CALL 8000H is an instruction of
 - (A) direct addressing mode
 - (B) indirect addressing mode
 - (C) register addressing mode
 - (D) immediate addressing mode
- 52. SUB A instruction in 8085 microprocessor
 - (A) resets the carry flag
 - (B) sets the zero flag
 - (C) sets the carry flag
 - (D) resets the zero flag
- 53. B, C, D, E, H, L register of 8085 microprocessor are called
 - (A) Special purpose register
 - (B) Bit addressable register
 - (C) General purpose register
 - (D) Flag register
- 54. 8086 is a
 - (A) 8 bit microprocessor
 - (B) 16 bit microprocessor
 - (C) 32 bit microprocessor
 - (D) 64 bit microprocessor

56.	8085	microprocessor is a
	(A) (B) (C) (D)	40 pin IC 14 pin IC 8 pin IC None of the above
57.	In 808	35 microprocessor, the first machine cycle of every instruction is
	(A) (B) (C) (D)	I/O machine cycle Memory read machine cycle Memory write machine cycle Opcode fetch machine cycle
58.	The f	unction ALE pin is
	(A) (B) (C) (D)	Multiplex address and data bus De-multiplex address and data bus Both (A) and (B) None of the above
59.	Exam	ple of data transfer instruction is
	(A)	LDA 2800 _H
	(B)	LXI 3000 _H
	(C) (D)	MVI B,67 _H All of the above
60.	How	many flag register present in 8086 microprocessor?
	(A) (B) (C) (D)	5 8 9 16

Maximum memory capacity of 8085 microprocessor is

55.

(A) 1 Kbyte(B) 1 Mbyte(C) 4 Kbyte(D) 64 Kbyte

61. RRC stands for

- (A) Rotate accumulator right without carry
- (B) Rotate accumulator left with carry
- (C) Rotate accumulator right with carry
- (D) Rotate accumulator left without carry

62. Instruction "DAA" stands for

- (A) Direct Addressing Accumulator
- (B) Decimal Adjust Accumulator
- (C) Direct Adjust Accumulator
- (D) Decimal Addressing Accumulator

63. Which is used to store critical pieces of data during subroutine and interrupt?

- (A) Stack
- (B) Queue
- (C) Accumulator
- (D) Data Register

64. Which is **not** a control bus signal?

- (A) Read
- (B) Write
- (C) Reset
- (D) None of the above

65. DMA stands for

- (A) Direct Memory Address
- (B) Direct Memory Allocation
- (C) Data Memory Assess
- (D) Data Memory Allocation

66. Ready pin of a microprocessor is used to

- (A) introduce wait state
- (B) indicate that microprocessor is ready to send output
- (C) provide DMA
- (D) indicate that microprocessor is ready to receive input

67.	Whic	h of the following is not true about the microprocessor?
	(A) (B)	Lower order address (A_0-A_7) bus and data bus are multiplex with each other 8 bit microprocessor
	(C)	It contains ALU, Stack pointer, program, counter, accumulator and general register
	(D)	Support pipeline process
	(2)	Support process
68.	Whic	h of the following is not property of TRAP interrupt?
	(A)	Non-maskable
	(B)	Non-vectored
	(C)	Edge-triggered
	(D)	Highest priority
69.	Цом	many address line present in 8086 microprocessor?
09.	110W	many address the present in 8080 inicroprocessor:
	(A)	16
	(B)	20
	(C)	24
	(D)	40
70.	The f	eatures of microcontroller is
70.	THE	catales of interocontroller is
	(A)	Built-in Internal memory
	(B)	Bit addressable
	(C)	Support interrupt
	(D)	All of the above
71.	Anv s	signed negative binary number is recognized by its
, 1.	11115	Agrica regard to chiary marrison is recognized by his
	(A)	MSB
	(B)	LSB
	(C)	Byte
	(D)	Nibble
72.	The re	epresentation of octal number $(532.2)_8$ in decimal is
	(A)	$(346.25)_{10}$
	(B)	$(532.864)_{10}$
	(C)	$(340.67)_{10}$
	(D)	$(531.668)_{10}$

73.	The largest two digit hexadecimal number is
	(A) (FE) ₁₆ (B) (FD) ₁₆ (C) (FF) ₁₆ (D) (EF) ₁₆
74.	In boolean algebra, the OR operation is performed by which properties?
	 (A) Associative properties (B) Commutative properties (C) Distributive properties (D) All of the above
75.	DeMorgan's theorem states that
	(A) (AB)' = A' + B' (B) (A + B) ' = A' * B (C) A' + B' = A'B' (D) (AB) ' = A' + B
76.	The expression $Y = (A + B)(B + C)(C + A)$ shows the operation.
	(A) AND (B) POS (C) SOP (D) NAND
77.	There are Minterms for 3 variables (a, b, c). (A) 0
	(B) 2 (C) 8 (D) 1
78.	Don't care conditions can be used for simplifying Boolean expressions in
	(A) registers(B) terms(C) K-maps(D) latches

79.	These IC for	e logic gates are widely used in design and therefore are available in
	101	
	(A)	sampling
	(B) (C)	digital analog
	(D)	systems
80.	The c	ode where all successive numbers differ from their preceding number by single
	bit is	
	(A)	Alphanumeric Code
	(B)	BCD
	(C)	Excess 3
	(D)	Gray
0.1	TDI C	
81.		ollowing switching functions are to be implemented using a decoder: $\sum_{n=1}^{\infty} (1, 2, 4, 8, 10, 14) f_{n}^{2} = \sum_{n=1}^{\infty} (2, 5, 0, 11) f_{n}^{2} = \sum_{n=1}^{\infty} (2, 4, 5, 6, 7)$
	11 = 2	$\sum m(1, 2, 4, 8, 10, 14) f2 = \sum m(2, 5, 9, 11) f3 = \sum m(2, 4, 5, 6, 7)$
	(A)	
	(B)	
	(C) (D)	4 to 16 line 5 to 32 line
	(D)	5 to 52 line
02	A	versal la sia sata is ana which are ha yead to generate any la sia function. Which
82.		versal logic gate is one which can be used to generate any logic function. Which following is a universal logic gate?
	or the	Tollowing is a universal logic gate.
	(A)	OR
	(B) (C)	AND XOR
	(D)	NAND
	4	
83.	The g	ates required to build a half adder are
		EV OD gate and NOD gate
	(A) (B)	EX-OR gate and NOR gate EX-OR gate and OR gate
	(C)	EX-OR gate and AND gate
	(D)	EX-NOR gate and AND gate
0.4	Total	number of inputs in a half addonic
84.	rotal	number of inputs in a half adder is
	(A)	
	(B) (C)	2 4
	(D)	1
	. /	

85.	In wh	ich of the following circuit the output is depending only on present input?
	(A)	Combinational circuit
	(B)	Analog circuit
	(C)	•
	(D)	Sequential circuit
	(-)	2.1
86.	An IC	C with four NOR gate is
	(A)	7486
	(B)	7404
	(C)	7432
	(D)	7402
	` /	
87.		is an example of a combinational circuit.
	(A)	Shift register
	(B)	Multiplexer
	(C)	Counter
	(D)	Flip-flop
88.	Any I	Boolean function can be implemented by multiplexer. The statement is
	(A)	false
	(A) (B)	true
	(C)	depends on Boolean function
	(D)	true for SOP and false for POS expression
	(D)	true for 501 and raise for 1 05 expression
89.	De m	ultiplexer is used to
	(A)	add binary numbers
	(B)	multiply binary numbers
	(C)	select data from many output line to a single input line
	(D)	distribute data from one input line to multiple output line
	W .	
90.	A prio	ority encoder is used to
	(A)	assign priority to different input
	(B)	convert binary to BCD
	(C)	<u> </u>
	(D)	None of the above

91.	ABCI	O-to-7 segment decoder is used to
	(A) (B) (C) (D)	convert gray to binary suitable for 7-segment display convert binary to gray suitable for 7-segment display convert Excess-3 to BCD suitable for 7-segment display convert BCD to a format suitable for 7-segment display
92.	When	both inputs of a J-K flip-flop is logic high, the output will
	(A)	set
	(B)	reset
	(C)	toggle
	(D)	undefined
93.	Which	h of the following is correct for a gated D-type flip-flop?
	(A)	The Q output is either SET (or RESET) as soon as the D input goes HIGH (or LOW)
	(B)	The output complement follows the input when enabled
	(C)	Only one of the inputs can be HIGH at a time
	(D)	The output toggles if one of the inputs is held HIGH
94.	The b	asic latch consists of
<i>)</i> 1.	THE O	usic luteli colloists of
	(A)	two inverters
	(B)	two comparators
	(C)	two amplifiers
	(D)	two adders
95.	SISO	(serial in serial out) shift register is capable to shift one bit data
	(A)	in both direction
	(B)	either right to left or left to right
	m` ′	not shift one bit data
	(D)	store in memory
	Fa	
96.	Three	T-flip-flop are connected to form a counter. Maximum state possible for
, 0.	VED.	er will be
	Count	·· · · · · · · · · · · · · · · · · ·
	(A)	1
	(B)	3
	(C)	8
	(D)	16

97.	A shift register with its complement output (Q') of the last stage connected to the input of the first stage is called					
	(A) (B) (C) (D)	Twisted –ring counter or Jonson counter Synchronous counter Asynchronous counter Ring counter				
98.	How	low to overcome race around condition in J-K flip-flop?				
	, ,	Using Master-Slave flip-flop Reduce time period of clock less than propagation delay Using edge trigger clock pulse All of the above				
99.	Minir	num number of flip flop required for Modulus 15 (MOD-15) counter is				
	` /	15 16 4 3				
100.	Asyno	chronous counter is not required in				
	(A) (B) (C) (D)	universal clock flip-flop state diagram All of the above				
101.	What	is the duty cycle of the output of an astable multivibrator?				
	(A) (B) (C) (D)	50% 100% 75% 55%				
102.	Whic	h of these is not a type of monostable multivibrator?				
	(A) (B) (C) (D)	Schimitt trigger as a monostable multivibrator Emitter coupled as a monostable multivibrator Using an op-amp 555 timer as a monostable multivibrator				

- 103. What is a square wave generator?
 - (A) Flip-flop
 - (B) Bi-stable multivibrator
 - (C) Astable multivibrator
 - (D) Monostable multivibrator
- 104. The transfer function of RC low-pass filter network

(A)
$$\frac{RCs}{(1 + RCs)}$$

(B)
$$\frac{1}{1 + RCs}$$

(C)
$$\frac{RC}{1 + RCs}$$

(D)
$$\frac{S}{1 + RCs}$$

- 105. If the branch in any network has a current source then the analysis is carried out by
 - (A) mesh
 - (B) node
 - (C) Supermesh
 - (D) Supernode
- 106. What will be the output of a K-type thermocouple at 100°C?
 - (A) 40 mV
 - (B) 400 mV
 - (C) 4000 mV
 - (D) 4 V
- 107. The output of a dc motor mainly depends on
 - (A) speed and torque
 - (B) speed and back emf
 - (C) speed and applied voltage
 - (D) speed and load voltage

108.		eal op-amp is used to make an inverting amplifier. The two input terminals are same potential because
	(A) (B) (C) (D)	the two input terminals are directly shorted the output impedance is infinity the open loop gain is infinity CMRR is infinity
109.	How	many inductors are there in the tank circuit?
	(1)	1
	(A)	
	(B)	
	(C)	
	(D)	4
110.	Activ	e element in the Colpitts oscillator is
110.	Acuv	e element in the Corpius oscinator is
	(\Delta)	Cell
		Voltage
		Diode
		Transistor
	(D)	Transistor
111.	Whic	h type feedback is used in Colpitts oscillator?
	(A)	Voltage series feedback
	(B)	Current series feedback
	(C)	Voltage shunt feedback
	(D)	Current shunt feedback
112.	Which	h of the following are not the characteristics of the crystal oscillator?
	(1)	Highly stable with time
		Highly stable with town a voture
		Highly stable with temperature
	VOID.	Highly selective
	(D)	Frequency depends on external resistors and capacitors
113.	The in	nductance in the equivalent circuit of crystal oscillator represents
	(A)	Interelectrode capacitance
	` ′	Compliance
		Viscous factor
	(D)	
	` /	

114.	Emiss	sion coefficient of germanium is
	(A)	1
	(B)	1.1
	(C)	
	(D)	
115.	When	the temperature increases, reverse saturation current
	(A)	increases
	(B)	decreases
	(C) (D)	does not depend on temperature either increase or decrease
	(D)	ettier increase of decrease
116.	Volta	ge drop produced by a diode at forward bias in ideal diode model is equal to
	, ,	0.7 V
		0.3 V
	(C) (D)	1.0 V 0 V
	(D)	
117	T	
117.	In ide	al diode model in forward bias is considered as
	(A)	
	(B)	perfect conductor
	(C) (D)	perfect insulator capacitor
	(D)	Сарасног
118.	Activ	e device can also be used as
	(4)	About 15 and
	(A) (B)	Amplifiers Chopper
	(C)	Convertor
	(D)	Invertor
4		
119.	The u	nit of gain is
	(A)	Joules
	(B) (C)	Decibels Unitless
	(C) (D)	Watts
	\ /	

120.	Diffusion capacitance is larger than transition capacitance					
	(A)	True				
	(B)	False				
	` /	Both are same				
	(D)					
	(D)	Depends on doping				
121.	Diffu	sion capacitance does not depend on				
	(A)	Dynamic conductance				
	(B)	Forward current				
	(C)	Doping concentration				
	(D)	Reverse resistance				
122.	What	is IC 723?				
	(
	(A)	A voltage regulator				
	(B)	A full wave rectifier				
	` /	A half wave rectifier				
	(D)	A clipper				
123.	In IC	7805, the minimum input voltage for proper functioning is				
	(A)	5 V				
	(B)	6 V				
	(C)	7 V				
	(D)	9 V				
124.	The c	urrent flowing into one input of the op-amp is 12 nA and it is 10 nA in the other.				
12		the input offset current.				
	I IIIG (the input offset current.				
	(A)	1 nA				
	(B)	2 nA				
	(C)	-2 nA				
	(D)	11 nA				
125.	Whic	h of the following statement is TRUE about op-amp?				
	(A)					
	(A)	In op-amp a level shifter has high input resistance which prevents loading				
	(D)	effect on the intermediate stage.				
	(B)	In op-amp a level shifter has low input resistance which prevents loading effect				
	(C)	on the intermediate stage. Level shifter is a circuit which can shift DC voltage level of a signal to very				
	(C)	Level similer is a circuit which can shift DC voltage level of a signal to very				

high voltage
(D) All statements given above are false

- 126. In an operational amplifier (op-amp), what does the term "common-mode rejection ratio (CMRR)" measure?
 - (A) The differential gain of the op-amp
 - (B) The ability to reject common-mode signals
 - (C) The bandwidth of the op-amp
 - (D) The input impedance of the op-amp
- 127. What is the primary advantage of a differential amplifier compared to a single-ended amplifier?
 - (A) Higher input impedance
 - (B) Higher voltage gain
 - (C) Better common-mode rejection
 - (D) Lower power consumption
- 128. What is the function of a diode limiter in analog electronics?
 - (A) Generate a fixed voltage reference
 - (B) Limit the amplitude of input signals
 - (C) Provide negative feedback
 - (D) Amplify signals
- 129. What is the purpose of using negative feedback in amplifier circuits?
 - (A) Increase distortion
 - (B) Decrease bandwidth
 - (C) Improve stability and linearity
 - (D) Increase noise
- 130. Which of the following devices can be used as a voltage-controlled resistor in analog circuits?
 - (A) Bipolar Junction Transistor (BJT)
 - (B) Field-Effect Transistor (FET)
 - (C) Operational Amplifier (Op-Amp)
 - (D) Zener Diode
- 131. What is the primary function of a phase-locked loop (PLL) in analog electronics?
 - (A) Frequency modulation
 - (B) Voltage regulation
 - (C) Frequency synthesis and synchronization
 - (D) Signal rectification

- 132. What does the term "bandwidth" refer to in the context of analog filters?
 - (A) The range of frequencies passed by the filter
 - (B) The attenuation of frequencies outside the pass band
 - (C) The phase shift introduced by the filter
 - (D) The impedance mismatch between input and output
- 133. Which type of filter exhibits a constant gain within its pass band and a steep roll-off beyond the cutoff frequency?
 - (A) Butterworth filter
 - (B) Chebyshev filter
 - (C) Bessel filter
 - (D) Elliptic filter
- 134. What is the function of an integrator circuit in analog electronics?
 - (A) Amplify signals
 - (B) Colpitts oscillator
 - (C) Generate square waves
 - (D) Perform mathematical integration of input signals
- 135. Which type of oscillator circuit utilizes a tuned LC tank circuit for frequency generation?
 - (A) Wien bridge oscillator
 - (B) Differentiate signals
 - (C) Hartley oscillator
 - (D) Phase-shift oscillator
- 136. What is the primary purpose of using a Schmitt trigger in analog circuits?
 - (A) Generate triangular waveforms
 - (B) Provide hysteresis and noise immunity
 - (C) Amplify signals
 - (D) Generate square waves
- 137. Which type of modulation is commonly used for transmitting analog signals over long distances?
 - (A) Amplitude Modulation (AM)
 - (B) Frequency Modulation (FM)
 - (C) Phase Modulation (PM)
 - (D) Pulse Width Modulation (PWM)

138. What is the purpose of a sample-and-hold circuit in analog signal processing? (A) Amplify signals (B) Store and maintain the value of a signal (C) Convert analog signals to digital (D) Filter out high-frequency noise What is the significance of the "linearity" of an amplifier in analog electronics? 139. (A) Ability to reject common-mode signals (B) Ability to produce distortion-free output (C) Ability to operate at high frequencies (D) Ability to handle large signal swings 140. In an active filter circuit, what role does the operational amplifier play? (A) Provide frequency-dependent feedback (B) Amplify the input signal (C) Introduce non-linearity (D) Provide power supply regulation Which technique is used to study crystalline nature of material? 141. (A) AFM (B) XPS (C) XRD (D) EDAX 142. A signal may have frequency components ranging from 0.001 Hz to 10 Hz. Which of the following types of coupling should be chosen in a multi stage amplifier designed to amplify this signal? (A) RC coupling (B) Direct coupling (C) Transformer coupling (D) Double tuned coupling 143. Which of the following parameters characterizes the dynamic behavior of an operational amplifier? (A) Input offset voltage (B) Input bias current (C) Slew rate

(D) Common-mode rejection ratio

144.	What is the primary purpose of using a cascode amplifier configuration?
	(A) Higher input impedance
	(B) Higher voltage gain
	(C) Better power efficiency
	(D) Improved frequency response
145.	What is the primary function of a Wien bridge oscillator in analog circuits?
	(A) Generate sinusoidal waveforms
	(B) Perform phase modulation
	(C) Provide frequency modulation
	(D) Convert digital signals to analog
146.	Which type of feedback configuration is commonly used to stabilize the gain of an
	operational amplifier?
	(A) Series feedback
	(B) Parallel feedback
	(C) Positive feedback(D) Negative feedback
	(D) Negative recuback
147.	Photo current in p-n junction solar cell is at
117.	Those current in p injunction south cent is at
	(A) 1 st quadrant
	(B) 2 nd quadrant
	(C) 3 rd quadrant
	(D) 4 th quadrant
	(D) 4 quadrant
148.	The depth of penetration of a wave in a lossy dielectric increases with increasing
	(A) Wavelength
	(B) Permeability
	(C) Conductivity
	(D) Permittivity
149.	A transmission line whose characteristic impedance is a resistance
	(A) must be a distortionless line
	(B) may not be a distortionless line
	(C) must be a lossless line
	(D) may not be a lossless line

- 150. What is the primary purpose of using a precision rectifier circuit in analog electronics?

 - (A) Amplify AC signals(B) Convert AC signals to DC
 - (C) Convert digital signals to analog
 - (D) Perform frequency modulation



	ANSWER KEY								
Subject Name: 606 ELECTRONICS									
SI No.	Key	SI No.	Key	SI No.	Key	SI No.	Key	SI No.	Key
1	D	31	D	61	A	91	D	121	D
2	A	32	С	62	В	92	A	122	A
3	D	33	A	63	A	93	A	123	С
4	В	34	D	64	C	94	A	124	В
5	A	35	С	65	A	95	В	125	A
6	D	36	A	66	A	96	C	126	В
7	С	37	A	67	D	97	A	127	С
8	В	38	С	68	В	98	D	128	В
9	A	39	В	69	В	99	C	129	С
10	D	40	A	70	D	100	A	130	В
11	C	41	D	71	A	101	A	131	С
12	A	42	С	72	A	102	A	132	A
13	A	43	D	73	C	103	C	133	A
14	A	44	С	74	D	104	В	134	D
15	В	45	A	75	A	105	В	135	С
16	C	46	D	76	В	106	C	136	В
17	С	47	A	77	С	107	A	137	A
18	В	48	В	78	С	108	C	138	В
19	D	49	C	79	В	109	A	139	В
20	C	50	D	80	D	110	D	140	A
21	В	51	Α	81	C	111	A	141	С
22	D	52	В	82	D	112	D	142	В
23	A	53	C	83	C	113	D	143	C
24	В	54	В	84	A	114	A	144	D
25	C	55	D	85	A	115	A	145	A
26	C	56	A	86	D	116	D	146	D
27	A	57	D	87	В	117	В	147	D
28	A	58	В	88	В	118	A	148	A
29	В	59	D	89	D	119	C	149	С
30	D	60	C	90	A	120	В	150	В